Contents STW45NM50

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STW45NM50 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate-source voltage	±30	V
I _D	Drain current (continuous) at T _C = 25 °C	45	Α
I _D	Drain current (continuous) at T _C = 100 °C	28.4	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	180	Α
P _{TOT}	Total dissipation at T _C = 25 °C	390	W
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
T _{stg}	T _{stg} Storage temperature range		°C
Tj	Operating junction temperature range		

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case		°C/W
R _{thj-amb}	R _{thj-amb} Thermal resistance junction-ambient		°C/W

Table 4: Avalanche characteristics

Symbol	Parameter		Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by $T_{j\text{max}}$)		А
Eas	Single pulse avalanche energy (starting T _J =25 °C, I _D =I _{AR} , V _{DD} =50 V)		mJ

⁽¹⁾Pulse width limited by safe operating area.

 $^{^{(2)}}I_{SD} \leq 45~A,~di/dt \leq 400~A/\mu s,~V_{DS(peak)} \leq V_{(BR)DSS},V_{DD} \leq 80\%~V_{(BR)DSS}$

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5: On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0 V	500			V
	Zara gata valtaga drain	V _{GS} = 0 V, V _{DS} = 500 V			10	
IDSS	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 500 \text{ V},$ $T_{C} = 125 ^{\circ}\text{C}^{(1)}$			100	μA
Igss	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 30 \text{ V}$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 22.5 A		0.08	0.1	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	3290	ı	pF
Coss	Output capacitance	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz},$	-	865	1	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	140	ı	pF
Coss eq. (1)	Equivalent output capacitance	$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{ to } 400 \text{ V}$	1	270	ı	pF
Qg	Total gate charge	$V_{DD} = 400 \text{ V}, I_D = 45 \text{ A},$	-	113	ı	nC
Q_{gs}	Gate-source charge	$V_{GS} = 10 \text{ V (see Figure 14:}$	-	17	-	nC
Q_{gd}	Gate-drain charge	"Test circuit for gate charge behavior")	-	82	- 1	nC
Rg	Gate input resistance	f = 1 MHz, I _D = 0 A	-	1.7	-	Ω

Notes:



⁽¹⁾Defined by design, not subject to production test.

 $^{^{(1)}}C_{oss~eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DS}

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 250 \text{ V}, I_D = 22.5 \text{ A}, R_G = 4.7 \Omega,$	-	29.1	-	ns
t _r	Rise time	V _{SS} = 10 V (see Figure 15: "Test circuit for inductive load switching and diode recovery times")	-	73.6	-	ns
$t_{r(Voff)}$	Off-voltage rise time	$V_{DD} = 400 \text{ V}, I_D = 45 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V} \text{ (see Figure 15: "Test")}$	-	20.8	-	ns
tf	Fall time	circuit for inductive load switching and		58.3	-	ns
tc	Cross-over time	diode recovery times")	-	67.6	-	ns

Table 8: Source-drain diode

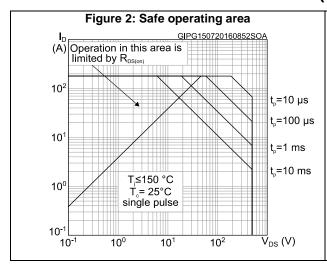
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		45	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		180	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 45 A, V _{GS} = 0 V	-		1.5	V
t _{rr}	Reverse recovery time	I _{SD} = 45 A, di/dt = 100 A/µs V _{DD} = 60 V (see Figure 15: "Test circuit for inductive load switching and diode recovery times")		454		ns
Qrr	Reverse recovery charge			9380		nC
I _{RRM}	Reverse recovery current			41.3		Α
t _{rr}	Reverse recovery time	I _{SD} = 45 A, di/dt = 100 A/μs		567		ns
Qrr	Reverse recovery charge	V _{DD} = 100 V, T _i = 150 °C (see Figure 15: "Test circuit for	_	12700		nC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	44.8		Α

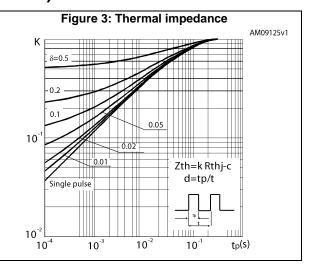
Notes:

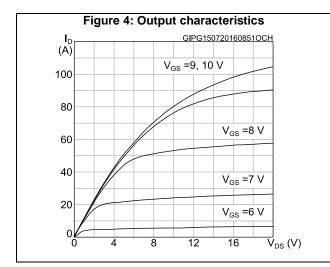
⁽¹⁾Pulse width limited by safe operating area.

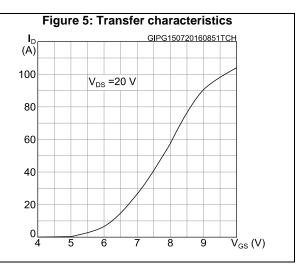
 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s,}$ duty cycle 1.5%

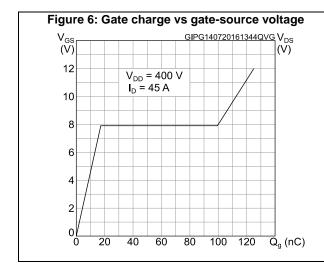
2.1 Electrical characteristics (curves)

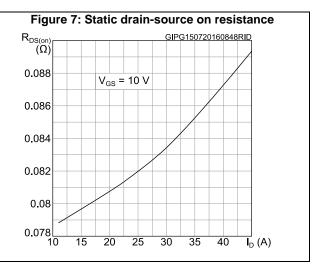








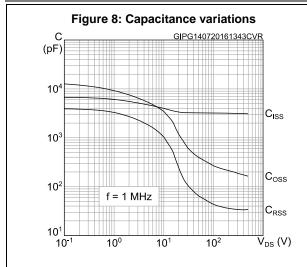




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STW45NM50 Electrical characteristics



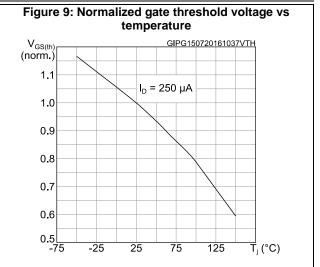
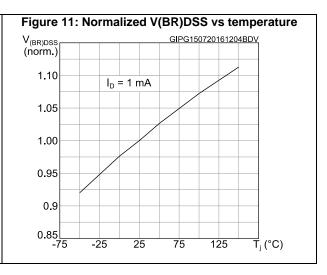
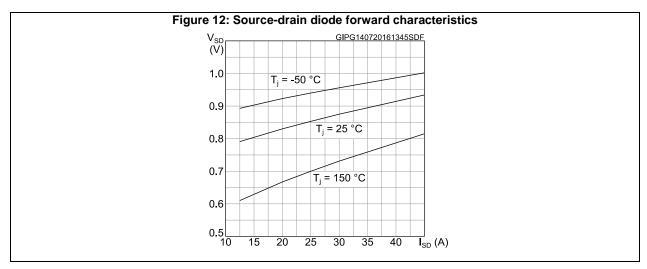


Figure 10: Normalized on-resistance vs temperature $R_{DS(on)}$ (norm.) 2.5 $V_{GS} = 10 \text{ V}$ $I_D = 22.5 \text{ A}$ 1.0 0.5 0.0 -75 -25 25 75 125 T_j (°C)







Test circuits STW45NM50

3 Test circuits

Figure 13: Test circuit for resistive load switching times

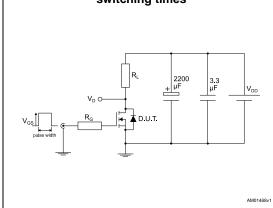


Figure 14: Test circuit for gate charge behavior

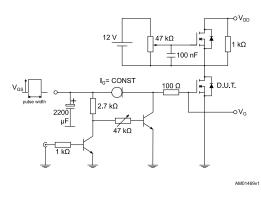


Figure 15: Test circuit for inductive load switching and diode recovery times

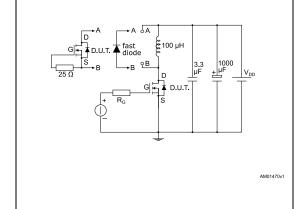


Figure 16: Unclamped inductive load test circuit

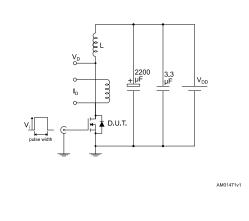
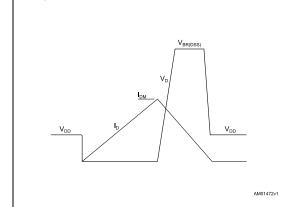
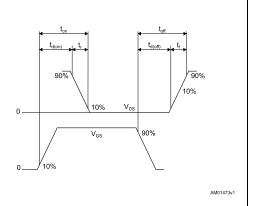


Figure 17: Unclamped inductive waveform



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Figure 18: Switching time waveform



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STW45NM50 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-247 package information

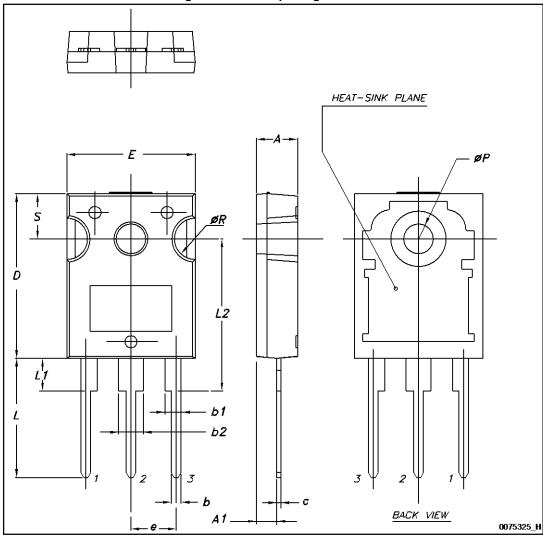


Figure 19: TO-247 package outline

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Table 9: TO-247 package mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

STW45NM50 Revision history

5 Revision history

Table 10: Document revision history

Revision	Changes			
4	Modified value on Source drain diode			
5	Modified values on Switching times			
6	Modified: Table 2: "Absolute maximum ratings", Table 3: "Thermal data", Table 4: "Avalanche characteristics", Table 5: "On/off states", Table 6: "Dynamic", Table 7: "Switching times" and Table 8: "Source-drain diode" Modified: Section 5.1: "Electrical characteristics (curves)" Updated: Section 7.1: "TO-247 package information"			
	5			

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